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April 27, 2005

(Minneapolis, Minn.)

Commissioner for Patents TO:

Attn: Theresa Doan

Patent Examining Corps

Facsimile Center P.O. Box 1450

Alexandria, VA 22313-1450 **933. - 5**937) FROM: Eric H. Olson

OUR REF: 303.355US4

TELEPHONE: 612-371-2131

FAX NUMBER 7034 <del>%</del>72-9306

\* Please deliver to Examiner Theresa Doan in Art Unit 2814. \*

Total pages of this transmission, including cover letter: 12 pgs. If you do NOT receive all of the pages described above, please telephone us at 612-373-6900 or fax us at 612-339-3061.

In re. Patent Application of: Leonard Forbes et al.

Examiner: Theresa Doan

Serial No.: 09/883,795

Group Art Unit: 2814

Filed: June 18, 2001

Docket No.: 303.355US4

Title: METHOD OF FORMING A DEVICE WITH A GALLIUM NITRIDE OR GALLIUM

ALUMINUM NITRIDE GATE

I hereby certify that this paper is being transmitted by facsimile to the U.S. Paters and Trademark Office

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PATENT

S/N Unknown

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Leonard Forbes et al. Applicant:

Examiner: Unknown

Serial No.:

Group Art Unit: Unknown

Unknown

Docket: 303.355US4

Filed:

Herewith

Title:

DEAPROM AND TRANSISTOR WITH GALLIUM NITRIDE OR GALLIUM

**ALUMINUM NITRIDE GATE** 

## INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents Washington, D.C. 20231

In compliance with the duty imposed by 37 C.F.R. § 1.56, and in accordance with 37 C.F.R. §§ 1.97 et. seq., the enclosed materials are brought to the attention of the Examiner for review in connection with the above-identified patent application. Pursuant to the provisions of MPEP 609, Applicants request that a copy of the 1449 form, initialed as being considered by the Examiner be returned to the Applicants.

In accordance with 37 C.F.R. §1.98(d), copies of the listed documents are not provided as these references were previously cited by or submitted to the U.S. Patent Office in connection with Applicants' prior U.S. application, Serial No. 09/141,392, filed on August 27, 1998, which is relied upon for an earlier filing date under 35 U.S.C. \$120.

Applicants respectfully request consideration of these references during prosecution of the above-identified matter. The Examiner is invited to contact the Applicants' Representative at the below-listed telephone number if there are any questions regarding this communication.

Respectfully submitted,

LEONARD FORBES ET AL.

By their Representatives,

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

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18 JUNE

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Date of Deposit: June 18, 2001

This paper or fee is being deposited on the date indicated above with the United States Postal Service pursuant to 37 CFR 1.10, and is addressed to the Commissioner for Patents, Box Patent Application, Washington, D.C. 20231.

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Form 1449*	Atty. Docket No.: 303.355US4	Serial No. Unknown	
INFORMATION DISCLOSURE STATEMENT	Applicant: Leonard Forbes et al.		
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<sup>\*</sup>Substitute Disclosure Statement Form (PTO-1449)

<sup>\*\*</sup>Examines. Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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"Subaricute Disclosure Statement Form [PTO-1449]

Examiner

Date Considered

<sup>\*\*</sup>EXMINER: Initial if citation considered, whether or not citation is in conformance with Mrfr 609; praw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicand.

			Atty. Docket No.:	303.355US4		Serial No.	Unknown
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<sup>\*\*</sup>EXAMINER: Initial if citation considered, whether or not citation is is conformance with MPEF 609, Braw line chrough citation is in conformance and not considered. Include copy of this form with next communication to applicant.

			Sheet 4 of 11
Form 1449*	Atty. Docket No.:	03.355US4	Serial No. Unknown
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		1	Sheet 5 of 11
Form 1449=	Atty. Docket No.:	303.355 <b>US4</b>	Serial No. Unknown
INFORMATION DISCLOSURE STATEMENT	Applicant: Leonar	l Forbes et al.	
BY APPLICANT (Use several sheets if necessary)	Filing Date: Herev	vith	Group: Unknown
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		<u> </u>	Sheet 6 of 11
Form 1449*	Atty. Docket No.	303,355US4	Serial No. Unknown
INFORMATION DISCLOSURE STATEMENT	Applicant: Leon	rd Forbes et al.	
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<u> </u>		<u> </u>	Sheet 7 of 11	
Form 1449*	Atty. Docket No.:			
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